



COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

DMC3018LSD

Product Summary

Device	V _{(BR)DSS}	R _{DS(on)} max	I _D Max T _A = +25°C
Q2	30V	20mΩ @ V _{GS} = 10V	9.1A
Q2	307	32mΩ @ V _{GS} = 4.5V	7.2A
Q1	-30V	45 m Ω @ V _{GS} = -10V	-6A
QI		65mΩ @ V _{GS} = -4.5V	-5A

Description

This new generation MOSFET has been designed to minimize the onstate resistance (R_{DS(ON)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- **Power Management Functions**
- Analog Switch
- Load Switch

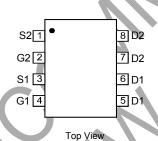
Features

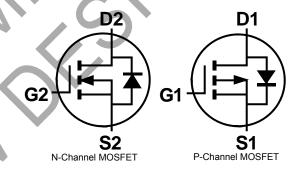
- Complementary Pair MOSFET
- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case:
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See Diagram
- Terminals: Finish Matte Tin annealed over Copper lead frame. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.072g (approximate)







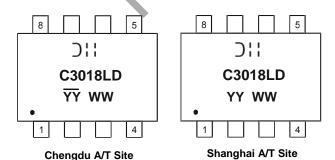
Ordering Information (Note 4)

Part Number	Case	Packaging
DMC3018LSD-13	SO-8	2,500/Tape & Reel

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. Notes:

- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



D!! = Manufacturer's Marking C3018LD = Product Type Marking Code YYWW = Date Code Marking YY or \overline{YY} = Year (ex: 14 = 2014) WW = Week (01 - 53)

YY = Date Code Marking for SAT (Shanghai Assembly/ Test site) YY = Date Code Marking for CAT (Chengdu Assembly/ Test site)

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Characteristic	Symbol	Value	Unit	
Drain Source Voltage		V _{DSS}	30	V
Gate-Source Voltage		V _{GSS}	±20	V
Drain Current (Note 5) $ T_A = +25^{\circ}C $ $ T_A = +70^{\circ}C $		I _D	9.1 7.7	А
Pulsed Drain Current (Note 6)		I _{DM}	32	Α

Maximum Ratings P-CHANNEL – Q1 (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Drain Source Voltage		V_{DSS}	-30	V
Gate-Source Voltage		V _{GSS} ±20		V
Drain Current (Note 5)	T _A = +25°C T _A = +70°C	ID	-6 -5	A
Pulsed Drain Current (Note 6)		I _{DM}	-21	A

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol Value	Unit
Power Dissipation (Note 5)	P _D 2.5	W
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$ 50	°C/W
Operating and Storage Temperature Range	T _J , T _{STG} -55 to +150	°C

Electrical Characteristics N-CHANNEL - Q2 (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)	OFF CHARACTERISTICS (Note 7)					
Drain-Source Breakdown Voltage	BV _{DSS}	30	_	_	V	V _{GS} = 0V, I _D = 250μA
Zero Gate Voltage Drain Current	IDSS	_	_	1	μA	V _{DS} = 24V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}	_	_	± 100	nA	V _{GS} = ±20V, V _{DS} = 0V
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(th)}	1	1.9	2.1	٧	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
Static Drain-Source On-Resistance	Process	_	18	20	mΩ	V _{GS} = 10V, I _D = 6.9A
Static Dialit-Source Off-Resistance	R _{DS(ON)}	_	29	32	1115.2	$V_{GS} = 4.5V, I_D = 5.0A$
Forward Transfer Admittance	Y _{fs}	_	10	—	S	$V_{DS} = 5V, I_D = 6.9A$
Diode Forward Voltage (Note 7)	V_{SD}	0.5	_	1.2	V	V _{GS} = 0V, I _S = 1A
DYNAMIC CHARACTERISTICS						
Input Capacitance	C _{iss}	_	631	_	pF	
Output Capacitance	Coss	_	147	_	pF	$V_{DS} = 15V, V_{GS} = 0V, f = 1.0MHz$
Reverse Transfer Capacitance	C _{rss}	_	99	_	pF	
Gate Resistance	R_G	_	0.9	_	Ω	V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz
SWITCHING CHARACTERISTICS						
Total Gate Charge	0		5.9			V_{DS} = 15V, V_{GS} = 4.5V, I_{D} = 7A
Total Gate Griange	Qg		12.4			$V_{DS} = 15V, V_{GS} = 10V, I_{D} = 9A$
Gate-Source Charge	Q_{gs}	_	1.8	_	nC	$V_{DS} = 15V$, $V_{GS} = 10V$, $I_{D} = 9A$
Gate-Drain Charge	Q_{gd}	_	3.4	_		$V_{DS} = 15V, V_{GS} = 10V, I_D = 9A$

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5. Device mounted on FR-4 PCB, on 2oz. Copper pads with $R_{\Theta JA}$ = 50°C/W 6. Repetitive rating, pulse width limited by junction temperature. Notes:

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^{7.} Short duration pulse test used to minimize self-heating effect.

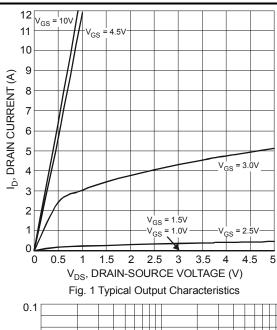


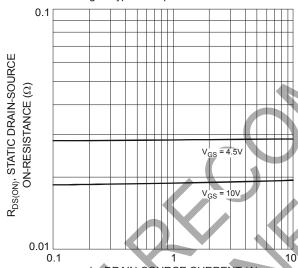
Electrical Characteristics P-CHANNEL – Q1 (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV _{DSS}	-30	_	_	V	V _{GS} = 0V, I _D = -250μA
Zero Gate Voltage Drain Current	I _{DSS}	_	_	-1.0	μΑ	V _{DS} = -24V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}	_	_	± 100	nA	V _{GS} = ±20V, V _{DS} = 0V
ON CHARACTERISTICS (Note 7)	'		u.	Į.	I.	
Gate Threshold Voltage	V _{GS(th)}	-1	-1.7	-2.1	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
Otatia Basia Osuasa On Basiatana		_	35	45		V _{GS} = -10V, I _D = -6A
Static Drain-Source On-Resistance	R _{DS} (ON)	_	56	65	mΩ	$V_{GS} = -4.5V, I_D = -5.0A$
Forward Transfer Admittance	Y _{fs}	_	8.2	_	S	$V_{DS} = -5V, I_D = -6A$
Diode Forward Voltage (Note 7)	V_{SD}	-0.5	_	-1.2	V	$V_{GS} = 0V, I_{S} = -1A$
DYNAMIC CHARACTERISTICS						
Input Capacitance	C _{iss}	_	722	_	pF	
Output Capacitance	Coss	_	114		pF	$V_{DS} = -15V$, $V_{GS} = 0V$, $f = 1.0MHz$
Reverse Transfer Capacitance	C _{rss}	_	92		pF	
Gate Resistance	R_{G}	_	1.9		Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1.0MHz$
SWITCHING CHARACTERISTICS						
Total Gate Charge	Qg		7.0 13.7	_	C	$V_{DS} = -15V$, $V_{GS} = -4.5V$, $I_{D} = -6A$ $V_{DS} = -15V$, $V_{GS} = -10V$, $I_{D} = -6A$
Gate-Source Charge	Q _{gs}	12	1.7		nC	$V_{DS} = -15V$, $V_{GS} = -4.5V$, $I_{D} = -6A$
Gate-Drain Charge	Qnd	17	4.1			V _{DS} = -15V, V _{GS} = -4.5V, I _D = -6A



N-CHANNEL





I_D, DRAIN-SOURCE CURRENT (A)
Fig 3 On-Resistance vs. Drain Current & Gate Voltage

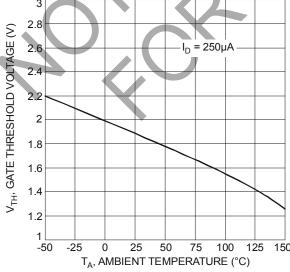
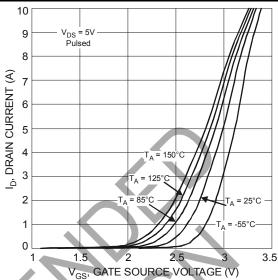
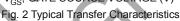


Fig. 5 Gate Threshold Variation vs. Ambient Temperature





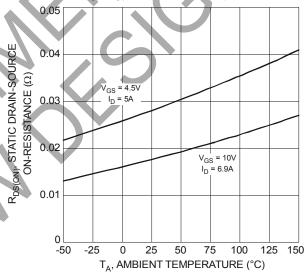
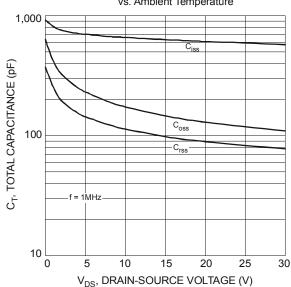
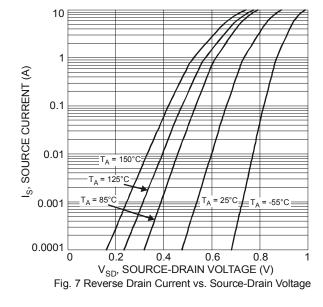


Fig. 4 Static Drain-Source On-Resistance vs. Ambient Temperature



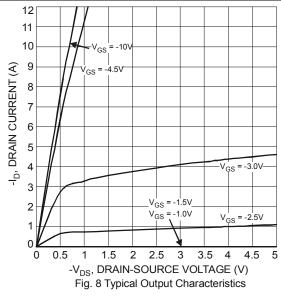


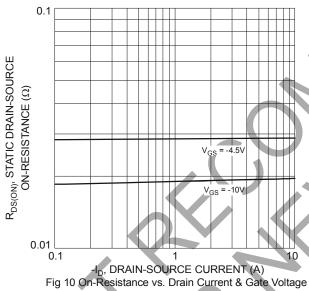


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P-CHANNEL





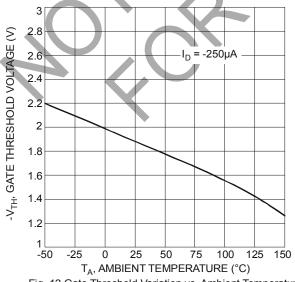
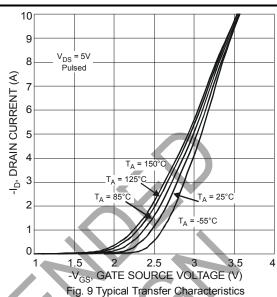
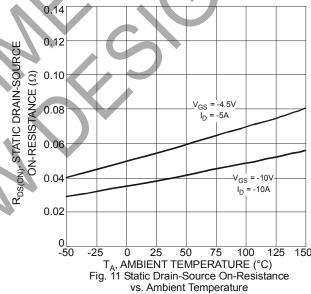
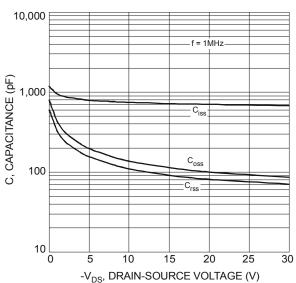


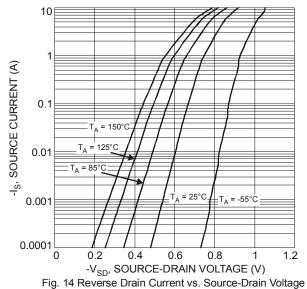
Fig. 12 Gate Threshold Variation vs. Ambient Temperature







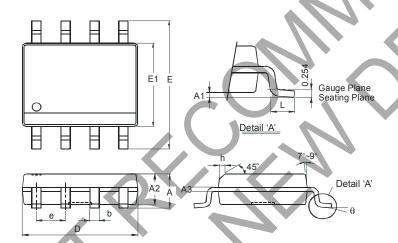




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Package Outline Dimensions

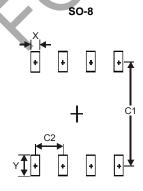
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SO-8						
Dim	Min	Max				
Α	-	1.75				
A1	0.10	0.20				
A2	1.30	1.50				
А3	0.15	0.25				
b	0.3	0.5				
D	4.85	4.95				
Е	5.90	6.10				
E1	3.85	3.95				
е	e 1.27 Typ					
h	-	0.35				
L	0.62	0.82				
θ	0°	8°				
All Dimensions in mm						

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
X	0.60
Y	1.55
C1	5.4
C2	1.27



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